

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6134887

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the ADDRESS OF THE ASSIGNEE previously recorded on Reel 052791 Frame 0133. Assignor(s) hereby confirms the ADDRESS IS: NO. 68 LIANHE ROAD CHEMICAL INDUSTRY PARK, SHANGHAI, CHINA 201507.
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HONG ZHANG	05/14/2020
FEI TENG	05/14/2020
JIANMIN YANG	04/27/2020
ZHISHENG WANG	04/26/2020
YI JHEN HUANG	05/14/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	EVONIK SPECIALTY CHEMICALS (SHANGHAI) CO., LTD.
<b>Street Address:</b>	NO. 68 LIANHE ROAD
<b>Internal Address:</b>	CHEMICAL INDUSTRY PARK
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	201507
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>PCT Number:</b>	CN2017103607
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	5714587790
<b>Email:</b>	patent@gandmpatent.com
<b>Correspondent Name:</b>	GRUNEBERG AND MYERS PLLC
<b>Address Line 1:</b>	1775 TYSONS BLVD.
<b>Address Line 2:</b>	5TH FLOOR
<b>Address Line 4:</b>	TYSONS, VIRGINIA 22102
<b>ATTORNEY DOCKET NUMBER:</b>	002675USPCT
<b>NAME OF SUBMITTER:</b>	MALIKA ASH SHAKUR
<b>SIGNATURE:</b>	/Malika Ash Shakur/

PATENT

<b>DATE SIGNED:</b>	06/03/2020
<b>Total Attachments: 13</b> source=002675USPCT_Corrective Assignments#page1.tif source=002675USPCT_Corrective Assignments#page2.tif source=002675USPCT_Corrective Assignments#page3.tif source=002675USPCT_Corrective Assignments#page4.tif source=002675USPCT_Corrective Assignments#page5.tif source=002675USPCT_Corrective Assignments#page6.tif source=002675USPCT_Corrective Assignments#page7.tif source=002675USPCT_Corrective Assignments#page8.tif source=002675USPCT_Corrective Assignments#page9.tif source=002675USPCT_Corrective Assignments#page10.tif source=002675USPCT_Corrective Assignments#page11.tif source=002675USPCT_Corrective Assignments#page12.tif source=002675USPCT_Corrective Assignments#page13.tif	

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6129457

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HONG ZHANG	05/14/2020
FEI TENG	05/14/2020
JIANMIN YANG	04/27/2020
ZHISHENG WANG	04/26/2020
YI JHEN HUANG	05/14/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	EVONIK SPECIALTY CHEMICALS (SHANGHAI) CO., LTD.
<b>Street Address:</b>	NO. 68 LIANHE ROAD CHEMICAL INDUSTRIAL PARK
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	201507
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>PCT Number:</b>	CN2017103607
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	5714587790
<b>Email:</b>	patent@gandmpatent.com
<b>Correspondent Name:</b>	GRUNEBERG AND MYERS PLLC
<b>Address Line 1:</b>	1775 TYSONS BLVD.
<b>Address Line 2:</b>	5TH FLOOR
<b>Address Line 4:</b>	TYSONS, VIRGINIA 22102
<b>ATTORNEY DOCKET NUMBER:</b>	002675USPCT
<b>NAME OF SUBMITTER:</b>	NANCY RILEY
<b>SIGNATURE:</b>	/Nancy Riley/
<b>DATE SIGNED:</b>	05/29/2020
<b>Total Attachments: 12</b>	

**ASSIGNMENT**

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as ASSIGNOR(S)) have made an invention entitled:

**TOUGH POLYAMIDE MOULDING MATERIAL**

for which an International application was filed on **September 27, 2017** and was assigned the Application No. **PCT/CN2017/103607**; and

WHEREAS, **Evonik Specialty Chemicals (Shanghai) Co., Ltd.**, a corporation of **China**, whose post office address is **No. 68 Lianhe Road**

**Chemical Industry Park, Shanghai, 201507 Shanghai, China** (hereinafter referred to as ASSIGNEE), is desirous of securing the entire right, title, and interest in and to the aforesaid invention and/or any improvements thereon in all countries throughout the world, and in and to the application(s) for Letters Patent on the aforesaid invention and/or any improvements thereon and the Letters Patent to be issued upon the aforesaid U.S. and/or International application(s);

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR(S), by these presents do hereby sell, assign and transfer to ASSIGNEE, the full and exclusive right, title and interest in and to the aforesaid invention and any improvements thereon, the aforesaid application(s) and all corresponding and/or counterpart foreign patent applications, all divisional, continuation, continuation-in-part, reissue, reexamination, extension, substitution, registration, renewal, extension, Supplementary Protection Certificates or the like, and any additional patent applications which claim priority to the aforesaid application(s), and all Letters Patent or comparable rights issuing thereon in the United States and in all foreign countries, and all applications for Letters Patent which may hereafter be filed for the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country and all Letters Patent which may be granted on the aforesaid invention and/or any improvements thereon in the United States and/or in any foreign country, together with the right(s) to claim priority to the aforesaid patent application(s) and/or any improvements thereon, and the ASSIGNOR(S) hereby authorize and request the United States Commissioner of Patents and Trademarks and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent or comparable rights issuing on any application as aforesaid to ASSIGNEE, or to its successors, assigns or legal representatives;

ASSIGNOR(S) hereby covenant that ASSIGNOR(S) have full right to convey the entire interest herein assigned, and that ASSIGNOR(S) have not executed, and will not execute, any agreement in conflict herewith;

ASSIGNOR(S) agree to communicate to ASSIGNEE or to its successors, assigns or legal representatives any and all facts known to them or any of them respecting said invention, and without further remuneration to testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and reexamination applications, make all rightful oaths and generally do all lawful acts to aid ASSIGNEE or its successors, assigns or legal

representatives to obtain and enforce proper patent protection for said invention in all countries and to enhance or perfect ASSIGNEE's title in and to the invention and patent rights therein.

ASSIGNOR(S) hereby authorize attorneys for ASSIGNEE to enter on this document any applicable serial numbers and filing dates after ASSIGNOR(S') execution of this document.

ASSIGNOR(S) hereby acknowledge an obligation to assign and do hereby assign all right, title and interest in and to the aforesaid invention and any improvements thereon to ASSIGNEE at the time the invention was made.

This Assignment may be executed in one (1) or more counterparts, each of which shall be deemed an original, but all of which together shall constitute one and the same instrument.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
14 day of May 2020

Hong Zhang

Hong ZHANG

55 Chundong Road  
Xinzhuang Industrial Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_\_

\_\_\_\_\_  
Jianmin YANG

Room 302, Building 16, No. 1111 Lijin Road,  
Pudong District  
200120 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
14 day of May 2018

Fei Teng

Fei TENG

55 Chundong Road  
Xinzhuang Industry Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_\_

\_\_\_\_\_  
Zhisheng WANG

Room 501, Building 57, Lane 47, West Guilin  
Road  
200233 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_\_

\_\_\_\_\_  
Yi Jhen HUANG

7F.-3, No. 146, Sec. 6, Minquan E. Rd., Neihu Dist.  
114 Taipei City  
Taiwan

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ASSIGNOR(S) hereby covenant that ASSIGNOR(S) have full right to convey the entire interest herein assigned, and that ASSIGNOR(S) have not executed, and will not execute, any agreement in conflict herewith;

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IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_.

\_\_\_\_\_  
Hong ZHANG

55 Chundong Road  
Xinzhuang Industrial Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
27 day of April 2020.

\_\_\_\_\_  
Jianmin YANG

Room 302, Building 16, No. 1111 Lijin Road,  
Pudong District  
200120 Shanghai  
China



IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_.

\_\_\_\_\_  
Fei TENG

55 Chundong Road  
Xinzhuang Industry Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_.

\_\_\_\_\_  
Zhisheng WANG

Room 501, Building 57, Lane 47, West Guilin  
Road  
200233 Shanghai  
China

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Yi Jhen HUANG

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\_\_\_\_\_  
Hong ZHANG

55 Chundong Road  
Xinzhuang Industrial Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_\_.

\_\_\_\_\_  
Jianmin YANG

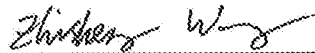
Room 302, Building 16, No. 1111 Lijin Road,  
Pudong District  
200120 Shanghai  
China

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\_\_\_\_\_ day of \_\_\_\_\_ 20\_\_\_\_.

\_\_\_\_\_  
Fei TENG

55 Chundong Road  
Xinzhuang Industry Park  
201108 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
26 day of April 2020.

  
\_\_\_\_\_

Zhisheng WANG

Room 501, Building 57, Lane 47, West Guilin  
Road  
200233 Shanghai  
China

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this  
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Yi Jhen HUANG

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Hong ZHANG

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\_\_\_\_\_  
Fei TENG

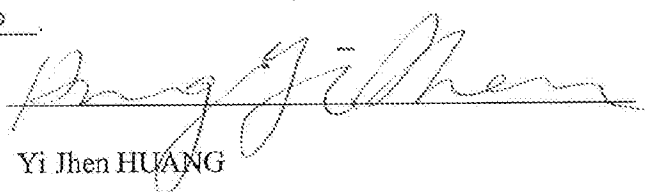
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Zhisheng WANG

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200233 Shanghai  
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14 day of May 2019.

  
Yi Jhen HUANG

7F.-3, No. 146, Sec. 6, Minquan E. Rd., Neihu  
Dist.  
114 Taipei City  
Taiwan